

System Overview

Description	Model	Resdoyl		S	Serial Number	
CCD Head	D U S	9 34P -	BR-DD) (CCD-19347	eiss
TE Cooler performance (~)		10-00	ligh	Ultra-high ✓	<u>s</u> H
Accessories	Power S	Supply Unit (I	PS -24)	and ITA e	PS -25	1167.0
200	0.1	- 30		8.8	V 1 18	
9541	SO-	LM-		MFL-		
Serial/Batch Number	,			0.1	802	
Other				. 193	Tv	1

[∇] Sensor types are defined in Table 1 using the last two letters in box Model Number.

CCD Details

Manufac	turer / Model No.	Pixels	Serial Number
E2V	CCD47-10	1024x1024, 13μm x 13μm	12262-05-02
E2V	CCD57-10	512x512, (FT), 13μm x 13μm	105 x 1 204
E2V	CCD77-00	512x512, 24μm x 24μm	8.05
	0340		801

Special Feature	(')	(*)
NIMO	Custom Mounting	Flange
Fringe Suppression	Custom Cables	
Shielded Anti-Blooming		

(~)		(~)
	NUV-Enhanced Parallel	
	Broadband VUV-NIR Parallel	
	Broadband VIS-NIR Parallel	
	Bose-Einstein 780nm Wedged	
	Other	
	(*)	Broadband VUV-NIR Parallel Broadband VIS-NIR Parallel Bose-Einstein 780nm Wedged

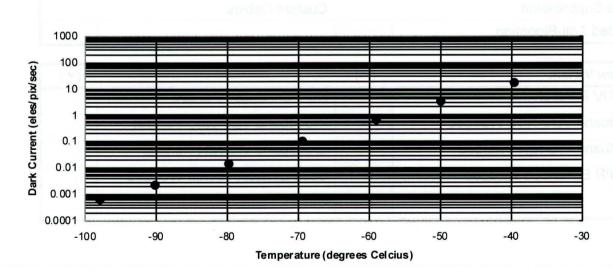


Summary of System Test Data

Readout Noise +1 and Base Mean Level

A/D Rate (MHz All 16 bit)	Preamp setting	CCD Sensitivity ◆3 eles per A/D count	Single Pixel Noise electrons	Full Vert Bin Noise electrons	Base Level ◆2 (Counts)
5	x1	6.8	34.2	33.0	992
5	x2	3.4	18.8	18.2	1446
5	x4	1.6	13.2	13.1	2792
3	x1	5.8	19.1	18.8	1154
3	x2	3.1	13.2	12.8	2100
3	x4	1.3	9.8	9.6	3776
1 1	x1	5.4	11.5	11.2	974
1	x2	2.7	7.9	7.8	1940
1	x4	1.3	461 / 6.6 T. AS	DASS 6.5	3975
0.05	x1	5.4	5.3	5.3	538
0.05	x2	2.6	4.1	4.0	1484
0.05	x4	1.3	3.8	3.7	3480
Satura	tion Signal p	er pixel	128246	Electron	s/pixel

CCD Dark Current



Minimum Dark Current Achievable ◆4	0.000687	electro	ns/pixel/s	ec
@ Sensor Temperature of ◆5	-98.07	°C	16	°C cooling Water
		With PS	-25	
CCD Dark Current Uniformity better than ◆6	0.394393	electro	ns/pixel/s	ec



Linearity and Uniformity

Linearity better than ◆7	1	% over 16 bits	in legacion solo
Response Uniformity better than ▶8	1.9	%	and the second

Response Defects

	Ce	entro	oid		Number of Pixels		Ce	entro	oid		Number of Pixels
(67	,	259)	1	(745	,	937)	1
	68	,	260)	1	(981	,	988)	1
(77	,	453)	1	(Χ	,	Х)	X
	145	,	607)	1	(,)	
(119	,	625)	1	(,)	
(616	,	783)	1	(,)	
	hite/B olumn				Column nun	nber	s indica	ted		X	X X
Tı	ap +1	1			. 60	o	(X,	Υ)	(Х	, X)

Dark Current Defects

Hot Spots ◆12			(X,Y)
Centroid	Number of Pixels	Centroid	Number of Pixels
(X , X) (X , X) (,) (,)	X		
Hot Columns ◆13	3 Column num	bers indicated X	X



Test Conditions

Readout Noise tested at	-80	°C with	16	°C water
Base Mean Level measured at	-80	°C with	16	°C water
Dark Current Uniformity tested at	-65	°C with	16	°C water
Blemishes tested at	-65	°C with	16	°C water

Custom Testing

Signed System Passed for Shipping

Pate Passed for Shipping

Hardware **HEADBOARD FPGA** Version # AB 20.24 Shipping Software SDK Version# **Testing** Software **SOLIS** SDK Version# 4.25.30007.0 2.97.30007.0

abla Table 1; Key code to define the meanings of the last two letters in the Model Number

Sensor Options					
OE	Open electrode	BU2	Back Illuminated (BI) + 250nm UV optimised		
FI	Front illuminated (FI)	BU	BI + UV (350nm) optimised		
UV	FI+UV coating	BV	BI + VIS (550nm) optimised)		
FO	FI + Fibre optic	BR-DD	BI + NIR +deepdepletion		
FI-DD	FI + deep depletion	BN	BI with no AR coating		

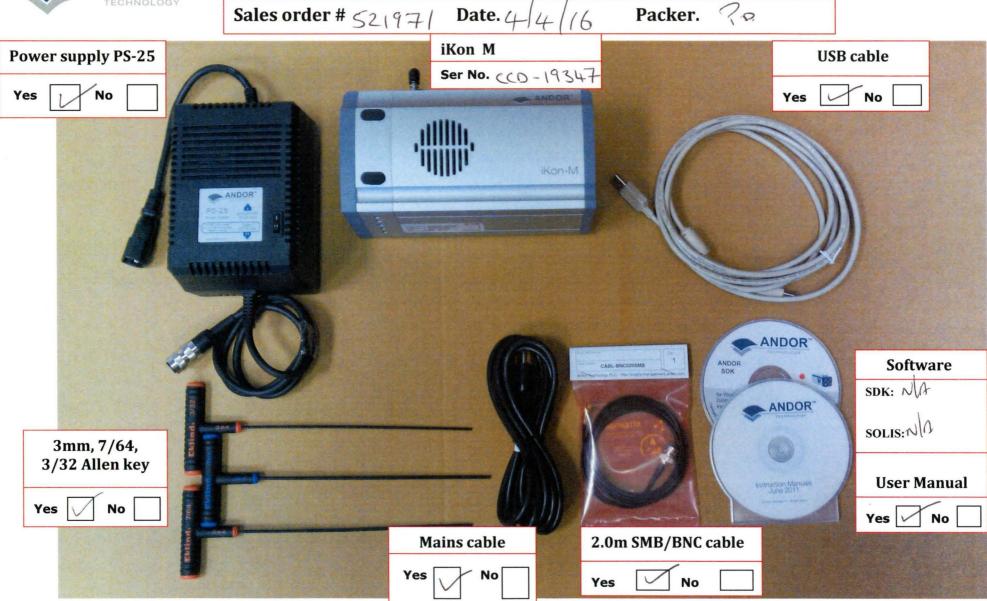


Performance Notes

- Readout Noise is measured for both single pixel (SP) and fully vertically binned (FVB) with the CCD in darkness at temperature indicated and minimum exposure time. Noise values will change with pre-amplifier gain selection [PAG].
- ◆2 Average electronic DC offset for CCD in darkness at temperature indicated and minimum exposure time under dark conditions measured by single pixel (SP) for imaging systems and by (FVB) for spectroscopic systems.
- ◆3 Sensitivity is calculated in photoelectrons per A/D count from measurements of the Photon Transfer Curve.
- Dark current falls exponentially with temperature. However, for a given temperature the actual dark current can vary by more than an order of magnitude from device to device. The devices are specified in terms of minimum dark current achievable rather than minimum temperature.
- Minimum temperature achieved for thermoelectric (TE) cooler set to maximum value with water cooling
- RMS (root mean square) deviation of dark current for fully binned operation for spectroscopic cameras, or full resolution image for imaging cameras, under dark conditions at temperature indicated (pixel/column defects not included). This variation is mainly cosmetic since it is fully subtractable without significant loss of performance.
- ◆7 Linearity is measured from a plot of Counts vs. Signal over the 16 bit dynamic range. Linearity is expressed as a %age deviation from a straight line fit. This quantity is not measured on individual systems.
- RMS (root mean square) deviation from the average response of the CCD in full resolution image for imaging cameras, illuminated with uniform white light (defects not included).
- ♦9 White/black pixels have signals >25% above/below the average (25% contrast) with uniform illumination across the sensor.
- ◆10 A black column is defined as having ≥ 10 black pixels for imaging cameras.
- Pixels which absorb charge as it is clocked through the defective area. When the light source is switched off, the signal from the trap appears to drop off more slowly than the signal from the surrounding pixels.
- ♦12 Hot spots are counted if they exhibit >50 times the maximum specified dark current at the test temperature indicated.
- ♦13 A column is considered defective if >10 pixels are affected, or if the column exhibits >2 times the maximum specified dark current at the test temperature indicated.

ANDOR™ TECHNOLOGY

ENI 00448 iKon-M Photo Packing List



Storage: K:\Packing Photos